

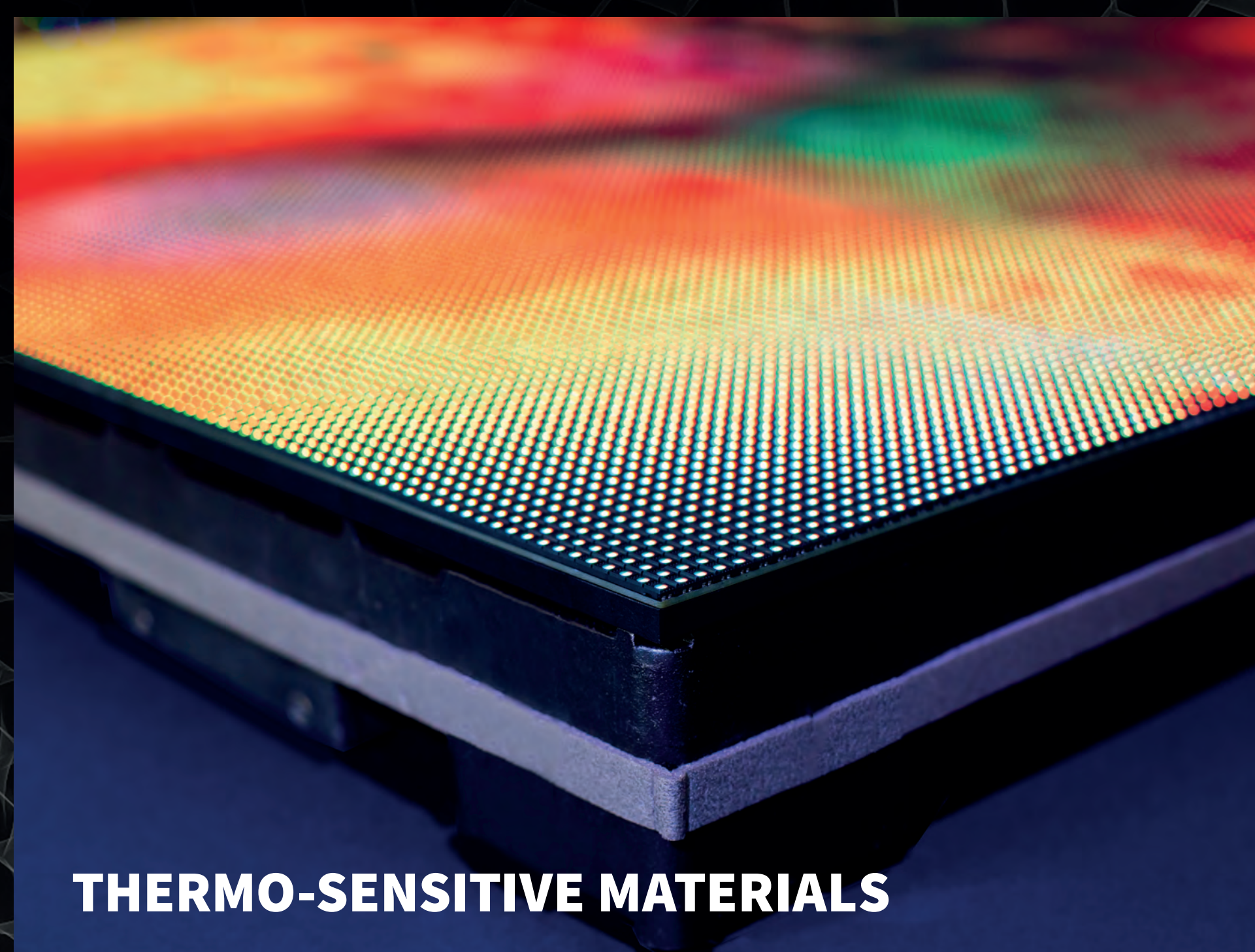
# INNOVATIVE MATERIALS COMBINATIONS FOR HIGH-END COMPONENTS

## STRESS-FREE SOLDERING + METALLIZATION

- Metals + Light Metals
- Ceramics + Glasses

## FUNCTIONAL COATINGS MADE BY BRAZING

- Metals
- Ceramics + Hard Metals



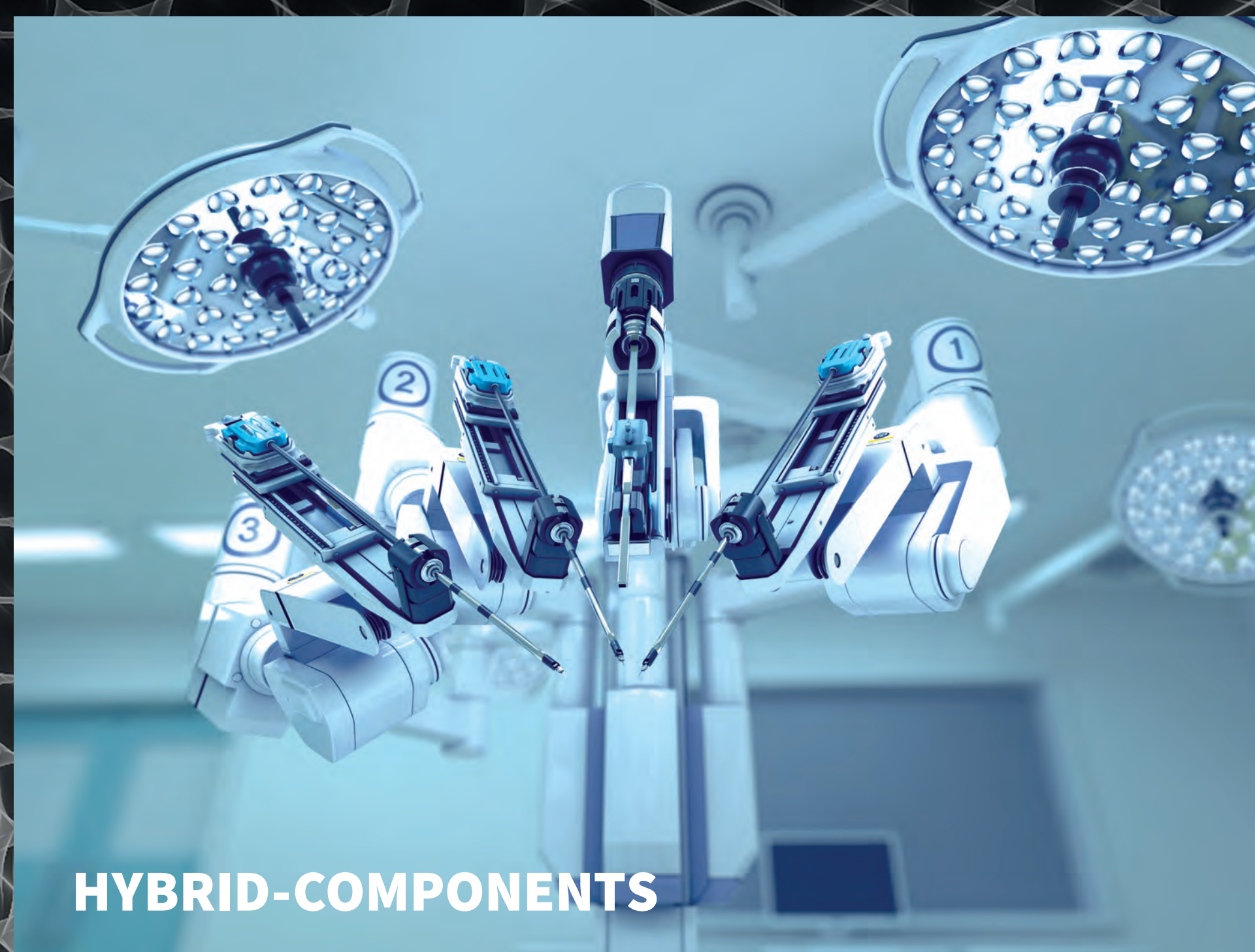
**THERMO-SENSITIVE MATERIALS**



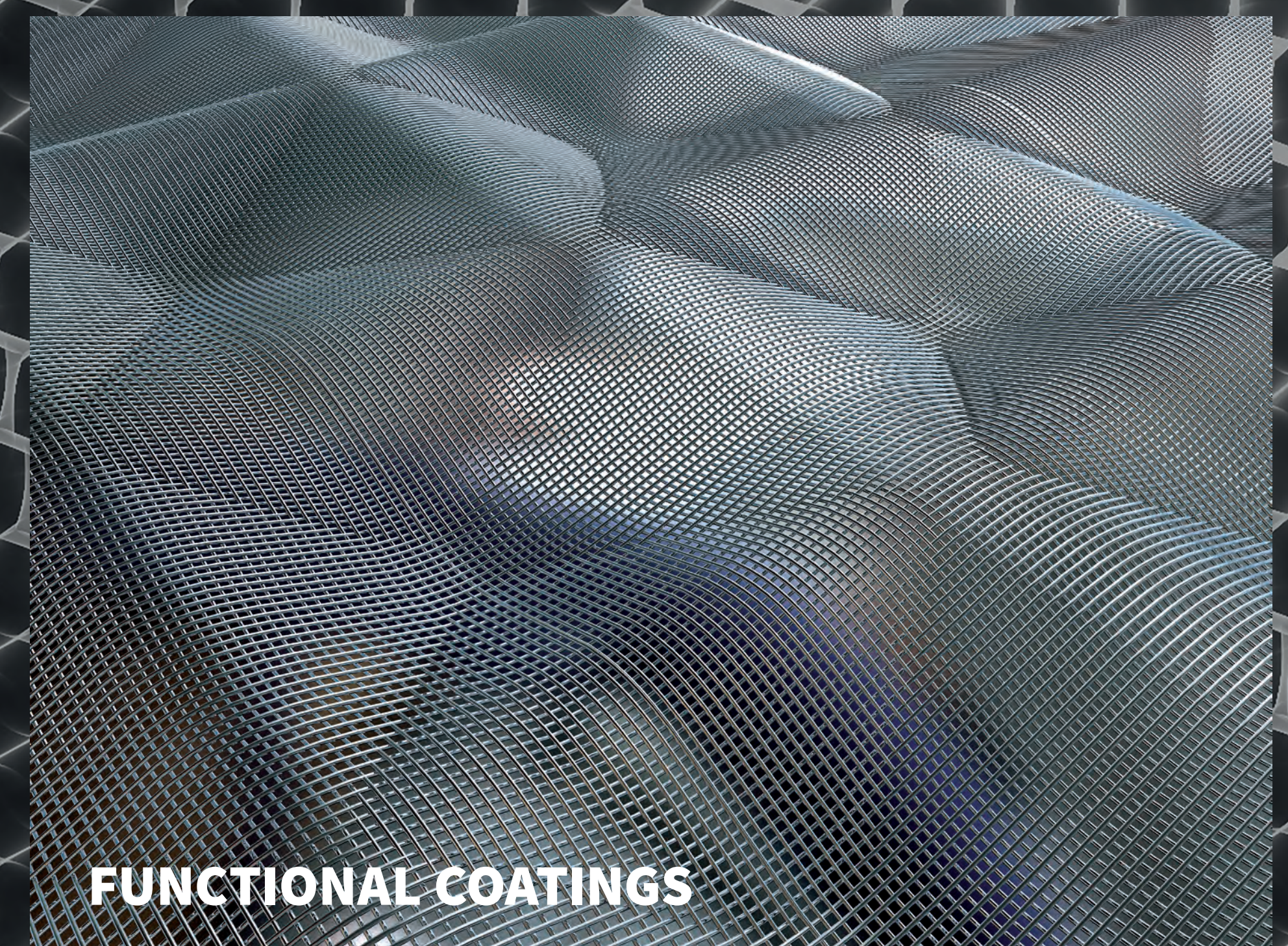
**HEATING-COOLING SYSTEMS**



**OPTICAL COMPONENT & SENSORIC ELEMENTS**



**HYBRID-COMPONENTS**

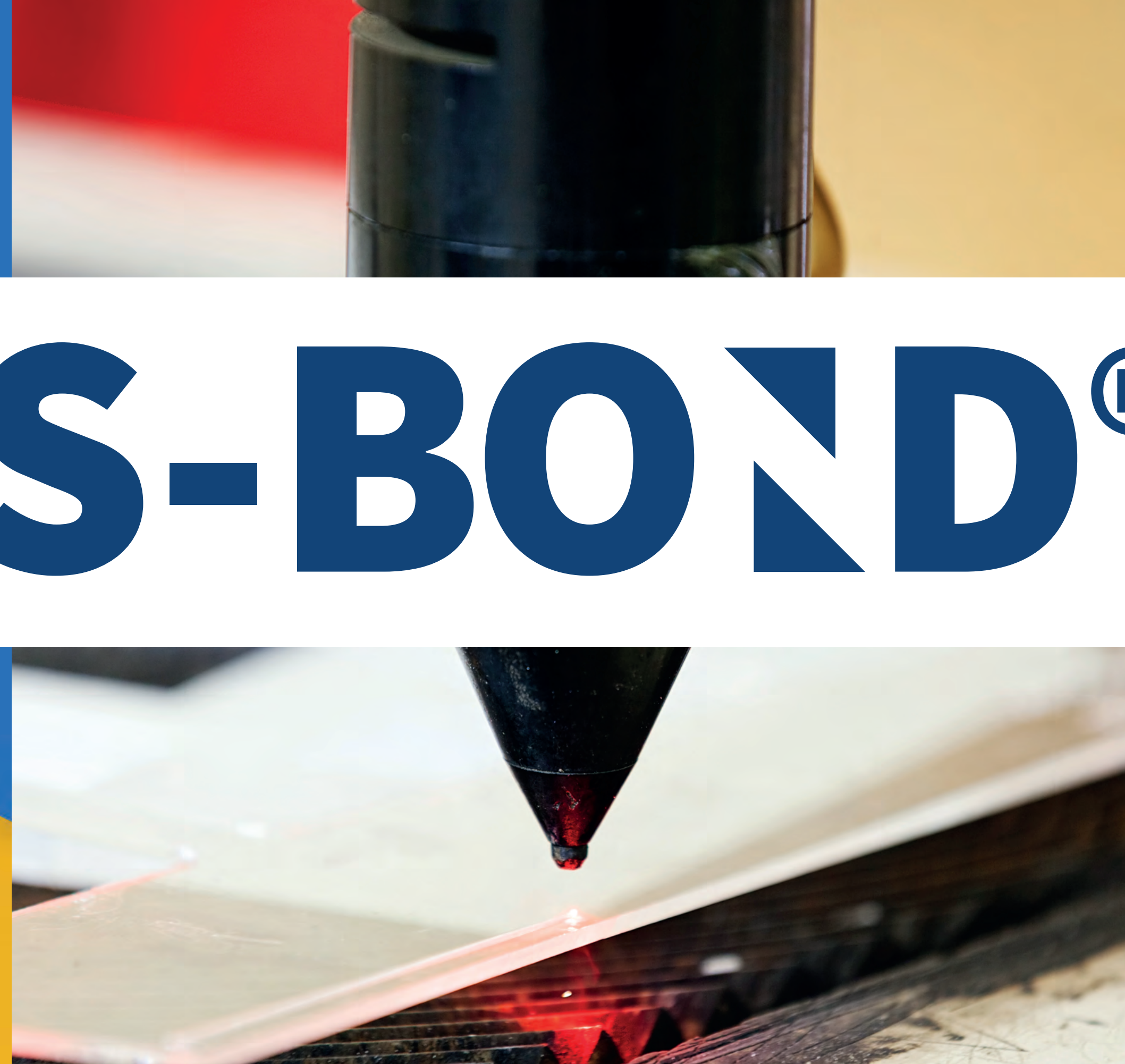
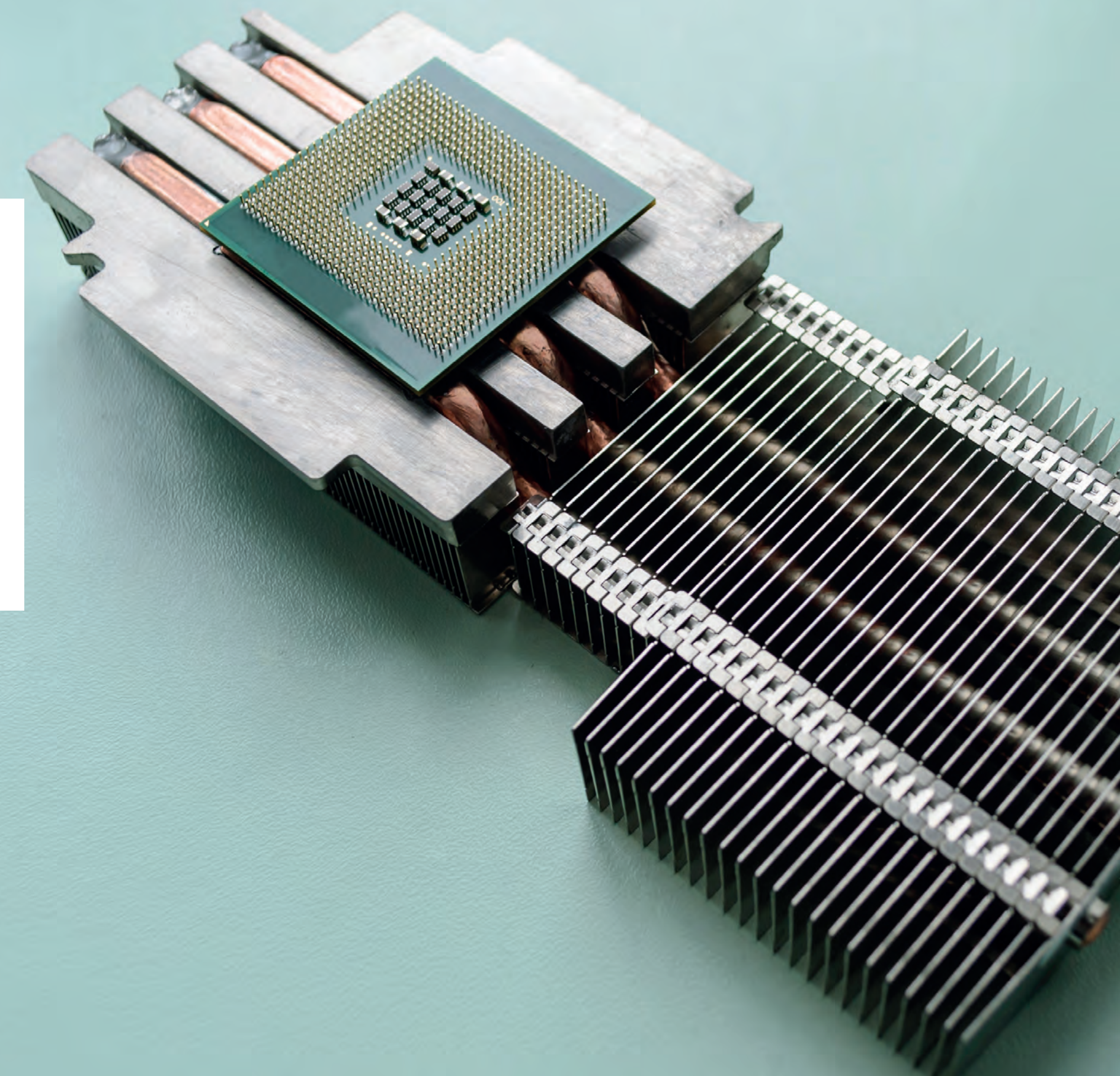


**FUNCTIONAL COATINGS**





# S-BOND®

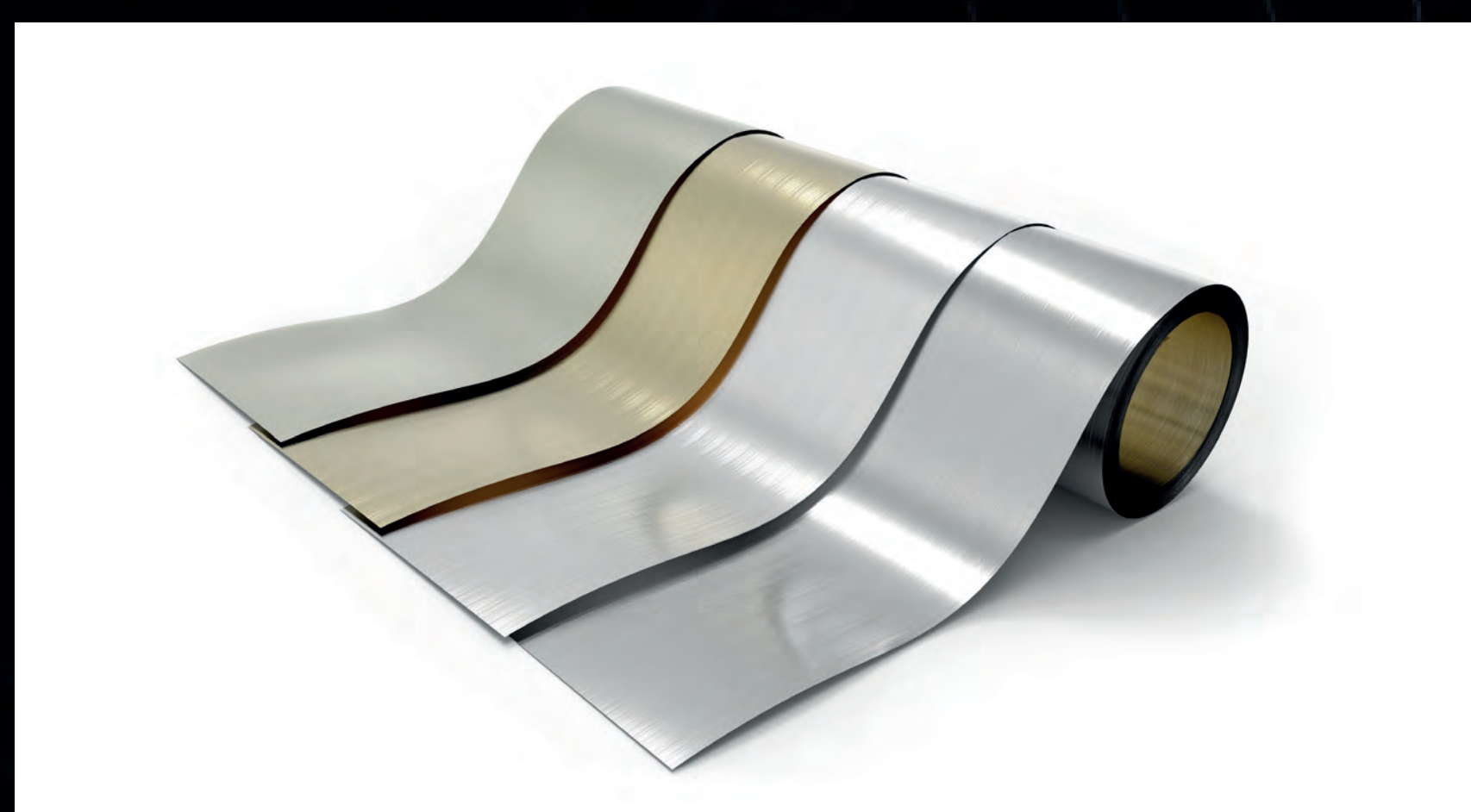


## ULTRASONIC-SOLDERING TECHNOLOGY

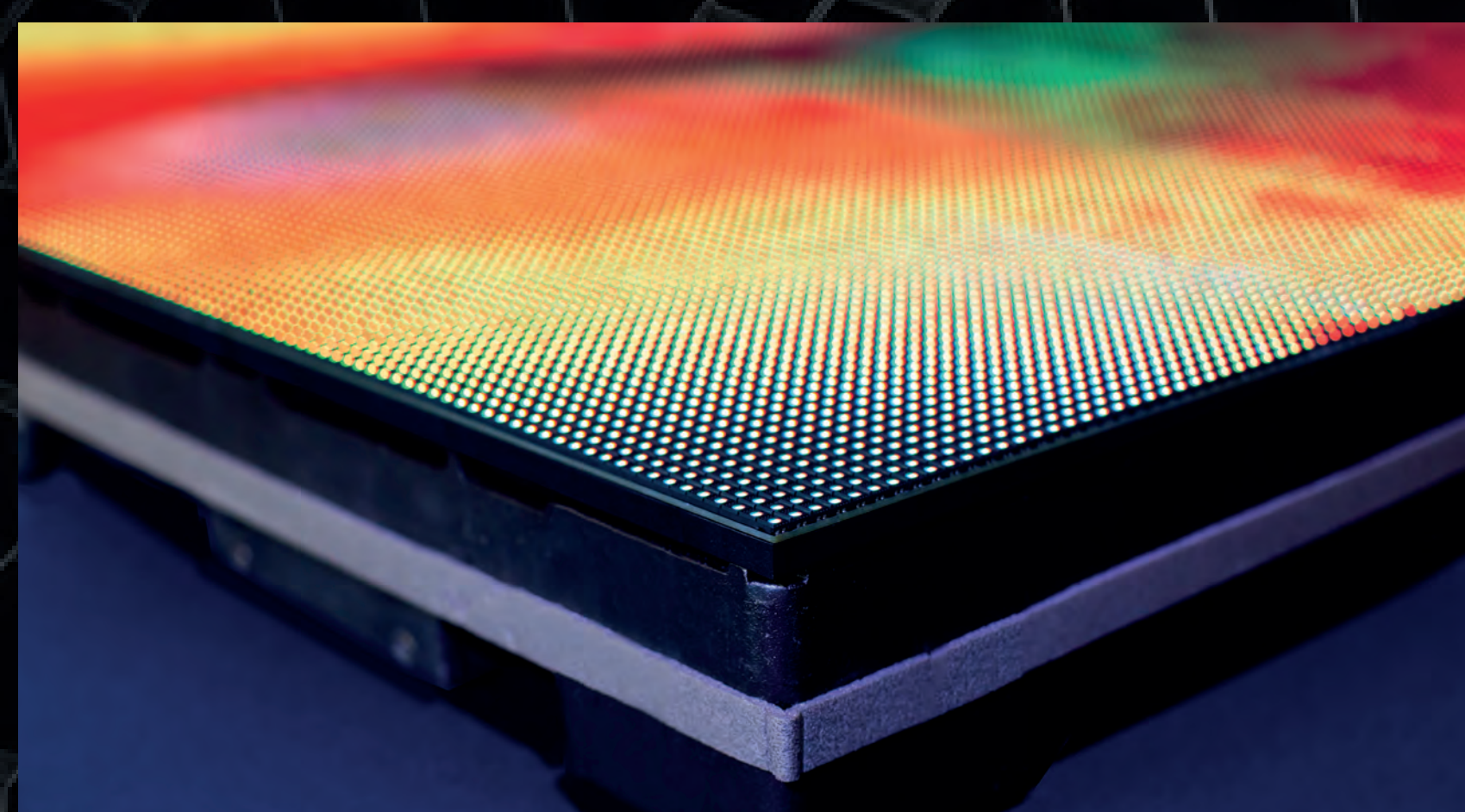
Joining and metallizing of metals, lightmetals, glasses and ceramics for thermal management applications in automotive, electronics and life science.

### KEY ASPECTS FOR TECHNOLOGY DEVELOPMENT

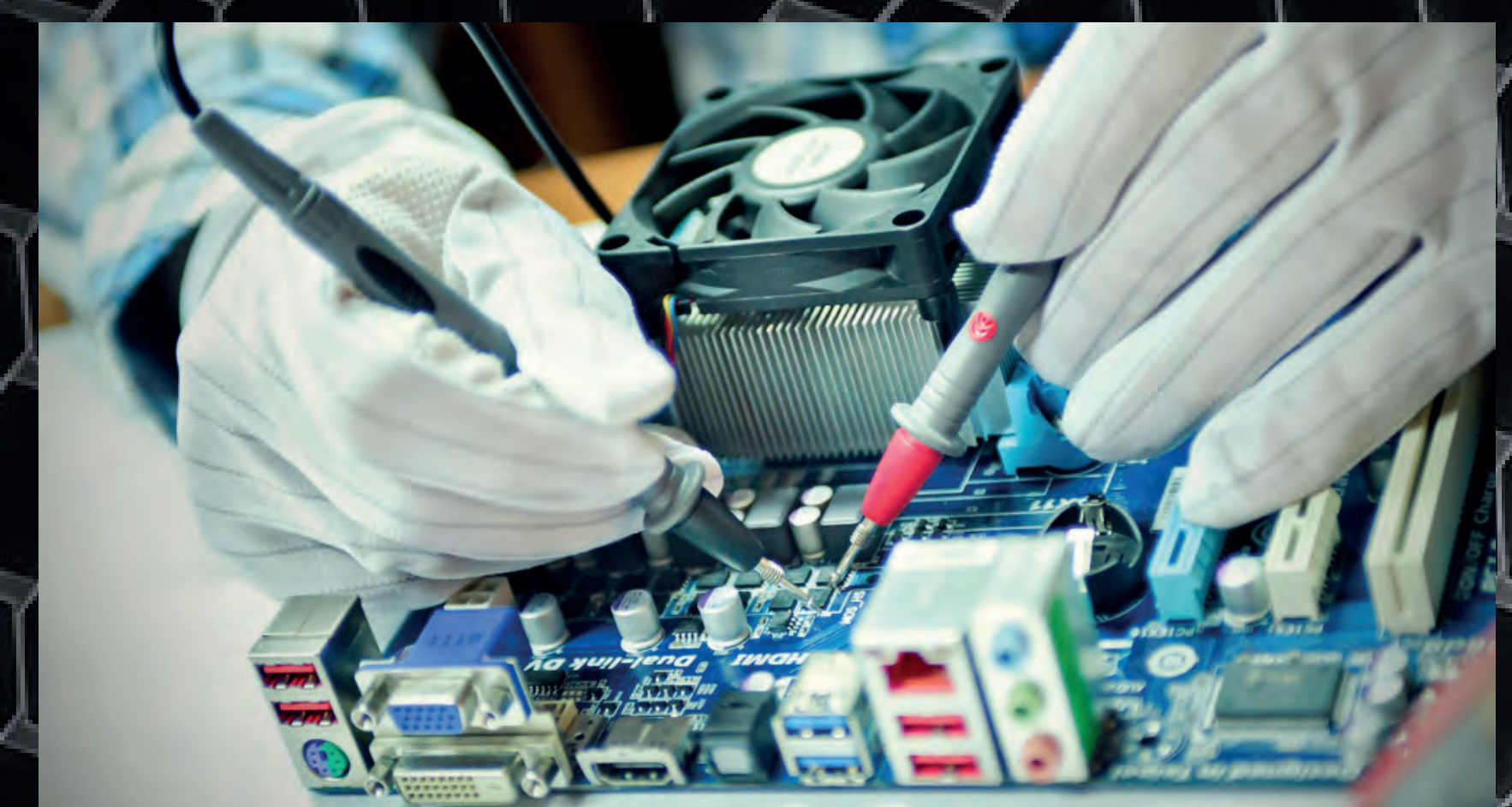
- Leadfree and fluxless soldering-technology regarding RoHS- und WEEE-Rules
- Environment-friendly atmospheric soldering without flux and heavy metals
- Metallization and soldering of metals, light metals, ceramics, glasses, composites (Si-SiC, Al-SiC, Al-Al<sub>2</sub>O<sub>3</sub>)
- Soldering temperatures ranging between 150 °C up to 480 °C
- Set up of complete line including materials, processes and equipments



### ULTRASONIC-SOLDERING MATERIALS



### ULTRASONIC-SOLDERING PROCESS



### ULTRASONIC-SOLDERING EQUIPMENTS

### DESCRIPTION OF THE ULTRASONIC-SOLDERING PROCESS

- Hermetic seal and suitable for cryogenic temperatures and vacuum applications
- High thermal resistance with good electrical and thermal conductivity properties
- Excellent behaviour under stress of thermal mismatch
- High shear strength of soldered joints made by metallurgical bondings
- Fluxless soldering process means no corrosion of soldered joints
- Economic solution for metallizing of materials which are difficult to wet
- Manifold solder materials are available for different applications and requirements
- Patented unleaded solder materials available regarding RoHS-Rules
- Ultrasonic soldering machines and processes can be adapted to individual applications
- Process runs automated or manually

### APPLICATIONS OF THE ULTRASONIC-SOLDERING PROCESS

- Surface metallization for contact soldering or casting
- Electronic-transformers-contacts
- Optical glasses, glass fibres
- Thermo-management, cooling plates, heaters, light weight structures
- Vacuum components, thin film substrates, targets, sensors, magnets, sintering metals
- Semiconductors, superconductors, solar cells
- Maintenance and new part production